# User's Guide TPS53915 Step-Down Converter Evaluation Module User's Guide



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# **1** Introduction

The TPS53915EVM-PWR587 evaluation module (EVM) uses the TPS53915 device. The TPS53915 device is a D-CAP3<sup>™</sup> mode, 12-A synchronous buck-converter with integrated MOSFETs. The device provides a fixed 1.2-V output at up to 12 A from a 12-V input bus.

# **2** Description

The TPS53915EVM-PWR587 is designed for a regulated 12-V bus to produce a regulated 1.2-V output at up to 12 A of load current. The TPS53915EVM-PWR587 is designed to demonstrate the TPS53915 device in a typical low-voltage application while providing a number of test points to evaluate the performance of the TPS53915 device.

# 2.1 Typical Applications

- Servers and storage
- Workstations and desktops
- Telecommunication infrastructure

### 2.2 Features

The TPS53915EVM-PWR587 features include the following:

- 12-A DC steady-state output current
- Support for a prebias-output voltage at start-up
- Jumper, J2, for enable function
- Jumper, J5, for auto-skip and forced-continuous-conduction-mode (FCCM) selection
- Jumper, J7, for extra 5-V input for further power saving purpose
- Convenient test points for probing critical waveforms

# **3 Electrical Performance Specifications**

#### Table 3-1. TPS53915EVM-PWR587 Electrical Performance Specifications<sup>(1)</sup>

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Input Characteristics					
Voltage range	V <sub>IN</sub>	5	12	18	V
Maximum input current	V <sub>IN</sub> = 5 V, Io = 8 A		2.5		А
No load input current	V <sub>IN</sub> = 12 V, I <sub>O</sub> = 0 A with auto-skip mode		1		mA
Output Characteristics					
Output voltage VOUT			1.2		V
Output voltage regulation	Line regulation ( $V_{IN}$ = 5 V – 14 V) with FCCM		0.2		%
	Load regulation ( $V_{IN}$ = 12 V, $I_O$ = 0 A – 8 A) with FCCM		0.5		%
Output voltage ripple	V <sub>IN</sub> = 12 V, I <sub>O</sub> = 8 A with FCCM		10		mVpp
Output load current		0		12	А
Output over current			15		А
Soft-start			1		ms
Systems Characteristics					
Switching frequency	V <sub>IN</sub> = 12 V, 1.2 V / 4 A		1000		kHz
Peak efficiency	V <sub>IN</sub> = 12 V, 1.2 V / 8 A		88.5		%
Full load efficiency			86.9		%
Operating temperature			25		°C

(1) Jumpers set to default locations, See Section 6.



## **4** Schematic







# 5 Test Setup

# 5.1 Test Equipment

**Oscilloscope** A digital or analog oscilloscope measures the output ripple. The oscilloscope must be set for the following:

- 1-MΩ impedance
- 20-MHz bandwidth
- AC coupling
- 1-µs / division horizontal resolution
- 20-mV / division vertical resolution

Test points TP7 and TP9 measure the output ripple voltage by placing the oscilloscope probe tip through TP7 and holding the ground barrel on TP9 as shown in Figure 5-1. Using a leaded ground connection can induce additional noise due to the large ground loop.

- **Voltage Source** The input voltage source VIN must be a 0 to 14-V variable-DC source capable of supplying 10 ADC. Connect VIN to J1 as shown in Figure 5-2.
- Multimeters V1: VIN at TP1 (VIN) and TP4 (GND). V2: VOUT at TP7 (VOUT) and TP9 (GND).
- Output Load The output load must an electronic constant-resistance-mode load capable of 0 to 15 ADC at 1.2 V.



Figure 5-1. Tip and Barrel Measurement for V<sub>OUT</sub> Ripple

#### **Recommended Wire Gauge:**

- 1. V<sub>IN</sub> to J1 (12-V input)
  - The recommended wire size is 1× AWG number 14 per input connection, with the total length of wire less than four feet (2 feet input, 2 feet return).
- 2. J3 to LOAD
  - The minimum recommended wire size is 2× AWG number 14, with the total length of wire less than four feet (two feet output, two feet return).



### 5.2 Recommended Test Setup



Figure 5-2. TPS53915EVM-587 Top Layer for Test Setup

#### Input Connections:

- 1. Prior to connecting the DC input-source, V<sub>IN</sub>, TI recommends to limit the source current from V<sub>IN</sub> to 10-A maximum. Ensure that VIN is initially set to 0 V and connected as shown in Figure 5-2.
- 2. Connect the voltmeter V1 at TP1 (VIN) and TP4 (GND) to measure the input voltage.

#### **Output Connections:**

- 1. Connect the load to J3 and set the load to constant-resistance-mode to sink 0-ADC before VIN is applied.
- 2. Connect the voltmeter V2 at TP7 (VOUT) and TP9 (GND) to measure the output voltage.

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#### 6 Configurations

All jumper selections must be made prior to applying power to the EVM. Configure this EVM using the following configuration selections.

#### 6.1 PMBus Address Selection

The PMBus address can be changed as shown in Table 6-1.

- . .

Table 6-1. PMBus Address Selection Settings						
	RESISTOR DIVID	ER RATIO (	(R <sub>HIGH</sub> ) (kΩ)	$(R_{LOW})$ $(k\Omega)$		
PMBus ADDRESS	(R <sub>LOW</sub> /R <sub>LOW</sub> +R <sub>HIGH</sub> )	MIN	МАХ	RESISTOR	RESISTOR	
0011111	> 0.55	57		1	300	
0011110	0.5100	0.4958	0.5247	160	165	
0011101	0.4625	04482	0.4772	180	154	
0011100	0.4182	0.4073	0.4294	200	143	
0011011	0.3772	0.3662	0.3886	200	120	
0011010	0.3361	0.3249	0.3476	220	110	
0011001	0.2985	0.2905	0.3067	249	105	
0011000	0.2641	0.2560	0.2725	249	88.7	
0010111	0.2298	0.2215	0.2385	240	71.5	
0010110	0.1955	0.1870	0.2044	249	60.4	
0010101	0.1611	0.1524	0.1703	249	47.5	
0010100	0.1268	0.1179	0.1363	249	36.0	
0010011	0.0960	0.0900	0.1024	255	27.0	
0010010	0.0684	0.0622	0.0752	255	18.7	
0010001	0.0404	0.0340	0.0480	270	11.5	
0010000	< 0.01	13		300	1	

For different switching frequency setting, please change R3 and R4 as shown in Table 6-1.

#### 6.2 Mode Selection

The MODE can be set by J5.

#### Table 6-2. Mode Selection

JUMPER SET TO:	MODE SELECTION
1 to 2 pin shorted	FCCM with 2× RC time constant
3 to 4 pin shorted <sup>(1)</sup>	FCCM <sup>(2)</sup> with 1× RC time constant <sup>(1)</sup>
5 to 6 pin shorted	FCCM <sup>(2)</sup> with 2× RC time constant
7 to 8 pin shorted	Auto-skip mode with 2× RC time constant
9 to 10 pin shorted	Auto-skip mode with 1× RC time constant

(1) Default setting

The device enters FCCM after PGOOD goes high. (2)

#### 6.3 VDD Pin Supply Selection

6

The controller can be enabled and disabled by J7.

Table 6-3. Enable Selection			
SET ON CONNECTION	ENABLE SELECTION		
R19 = 0 Ω <sup>(1)</sup>	VDD pin connected to VIN pins <sup>(1)</sup>		
R19 = Open	VDD pin disconnected to VIN pins		

(1) Default setting: the VDD pin connected to the VIN pins through R19.

For power up, input J7 with proper voltage. The VDD pin input voltage range is from 4.5 V to 25 V.

# 7 Test Procedure

# 7.1 Line and Load Regulation and Efficiency Measurement Procedure

- 1. Set up the EVM as described in Section 5 and Figure 5-2.
- 2. Ensure the load is set to constant-resistance mode and to sink at 0 ADC.
- 3. Ensure all jumper setting are configured as shown in Section 6.
- 4. Ensure the jumper provided in the EVM shorts on J2 before  $V_{IN}$  is applied.
- 5. Increase  $V_{\text{IN}}$  from 0 V to 12 V. Use V1 to measure input voltage.
- 6. Remove the jumper on J2 to enable the controller.
- 7. Use V2 to measure the  $V_{\text{OUT}}$  voltage.
- 8. Vary the load from 0 ADC to 10 ADC,  $V_{\text{OUT}}$  must remain in load regulation.
- 9. Vary  $V_{\text{IN}}$  from 8 to 14 V,  $V_{\text{OUT}}$  must remain in line regulation.
- 10. To disable the converter, place the jumper on J2.
- 11. Decrease the load to 0 A
- 12. Decrease  $V_{IN}$  to 0 V.

# 7.2 PMBUS Setup and Verification

The TPS53915EVM-PWR587 contains a  $10-\Omega$  series resistor in the feedback loop for loop response analysis.

- 1. Download the Graphical User Interface (GUI) from www.Tl.com.
- 2. Type *fusion* in the TI search bar.
- 3. Select *FUSION\_DIGITAL\_POWER\_DESIGNER* from the search result.
- 4. Download and install the latest release version of the software. The most current version to date is version 1.8.325 of the Fusion Digital Power Designer.
- 5. Connect the USB Interface Adaptor EVM (see www.ti.com for more information) to J4 of the EVM. Ensure that Pin 1 of the USB interface adaptor (red wire) is connected correctly to Pin 1 of J4 on the EVM.
- 6. Connect the USB wire of the USB interface adaptor to one of the USB ports on the computer tower.
- 7. Ensure that the EVM is powered up and connected to the USB interface adaptor before opening the Fusion Designer GUI.
- 8. Double click the shortcut icon on the desktop for the Fusion Designer GUI. Use the *online* version.
- 9. Double click on the *TPS40400, TPS4042x, ect (DEVICE CODE)* from the *Select Device Scanning Mode* window as shown in Figure 7-1.
- 10. When the GUI is loaded (see Figure 7-2), verify communication between the GUI and the EVM by changing the frequency of the EVM.

#### Note

The TPS53915EVM is pre-set to a 400-KHz switching frequency.

- 11. Use the oscilloscope to monitor the switching frequency on the EVM on TP6.
- 12. Select a different frequency by clicking on the drop down box of the *FREQUENCY\_CONFIG:TPS53819* (*TPS5391X*).
- 13. Click on Write to Hardware and monitor the change of the switching frequency on the oscilloscope.

See the *TPS53915 1.5 to 18 V (4.5 to 25 V bias) Input, 12-A Single Synchronous Step-Down SWIFT™ Converter Data Sheet* for more information regarding PMBUS registers.

**TRUMENTS** 

www.ti.com

Version 1.8.325 [2013-0	5-071
Select Device Scanning	g Mode
Select the method the GL	JI should use to scan for device(s) on the I2C bus:
UCD Controllers and	d Sequencers, Isolated Controllers (DEVICE ID)
UCD92xx, UCD91xx, UCD91xx, UCD91xx, UCD92xx, UCD91xx, UCD	JCD90xx, Isolated, etc. The GUI will scan the bus for devices that respond to nand. This is a Texas Instruments manufacturing specific command (read block
TPS40400, TPS404	2x, etc (DEVICE_CODE)
Analog power conver Instruments DEVICE_	ters and controllers. The GUI will scan for devices that respond to the Texas CODE command (read word 0xFC).
TPS544x24,, etc (I	<u>C_DEVICE_ID)</u>
Analog power conver Instruments IC_DEVI	ters and controllers. The GUI will scan for devices that respond to the Texas CE_ID command (read block 0xAD).
DEVICE ID and DEV	/ICE_CODE
Scan for DEVICE_ID a do not know which o this mode.	IND DEVICE_CODE. Use this option if you have a mix of devices on the bus or f DEVICE_ID or DEVICE_CODE your device supports. Scanning takes longer in
Define Custom Sca	n List
You can configure on	ly certain addresses to be scanned by clicking this link. For each address, you
can select the scan m	node to use.
this mode. Define Custom Scar You can configure on	n List ly certain addresses to be scanned by clicking this link. For each address, yo



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Test Procedure



Fusion Digital Power Designer v1.8.325 [2013-05-07] TPS53819A/TPS53912/TPS53913/TPS53915 @ Address 31d USB Adapter v1.0.10 [PEC; 400 kHz]

Figure 7-2. GUI for the Fusion Digital Power Designer

# 7.3 Control-Loop Gain and Phase-Measurement Procedure

The TPS53915EVM-PWR587 contains a  $10-\Omega$  series resistor in the feedback loop for loop response analysis.

- 1. Set up the EVM as described in Section 5 and Figure 5-2.
- 2. Connect the isolation transformer to the test points marked TP5 and TP8.
- Connect the input-signal amplitude-measurement probe (channel A) to TP10. Connect the output-signal amplitude-measurement probe (channel B) to TP11.
- 4. Connect the ground lead of channel A and channel B to TP15.
- 5. Inject around 20 mV or less signal through the isolation transformer.
- 6. To measure control-loop gain and phase margin, change the frequency from 100 Hz to 1 MHz using a 10-Hz or less post filter.
- 7. Disconnect the isolation transformer from the bode-plot test points before making other measurements.
  - Signal injection into feedback can interfere with the accuracy of other measurements.



# 7.4 List of Test Points

Table 7-1. Test Point Functions				
TEST POINTS	NAME	DESCRIPTION		
TP1	VIN	Converter input supply voltage		
TP2	VREG	LDO voltage		
TP3	PGOOD	Power good output		
TP4	PGND	Power ground		
TP5	СНВ	Input B for loop injection		
TP6	SW	Switch Node		
TP7	VOUT	VOUT terminal +		
TP8	CHA	Input A for loop injection		
TP9	PGND	Power ground		
TP10	RF	RF pin		
TP11	TRIP	TRIP pin		
TP12	EN	Enable pin		
TP13	VDD	VDD pin		
TP14	MODE	MODE pin		
TP15	AGND	Analog ground		

## 7.5 Equipment Shutdown

Follow these steps when shutting down the equipment.

- 1. Shut down load
- 2. Shut down VIN



# 8 EVM Assembly Drawing and PCB Layout

The following figures show the design of the TPS53915EVM-PWR587 printed circuit board (see Figure 8-1 through Figure 8-8). The EVM has been designed using a six-layer 2-oz copper-circuit board.



Figure 8-1. TPS53915EVM-587 Top-Layer Assembly Drawing



Figure 8-2. TPS53915EVM-587 Bottom-Layer Assembly Drawing





Figure 8-3. TPS53915EVM-587 Top Layer, Copper



Figure 8-4. TPS53915EVM-587 Layer Two, Copper





Figure 8-5. TPS53915EVM-587 Layer Three, Copper









Figure 8-7. TPS53915EVM-587 Layer Five, Copper



Figure 8-8. TPS53915EVM-587 Bottom Layer, Copper



# 9 Bill of Materials

Table 9-1. EVM Components	List (Based on the Scher	natic, see Figure 4-1)
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DESIGNATOR	QUANTITY	VALUE	DESCRIPTION	PACKAGE REFERENCE	PART NUMBER	MANUFACTURER
C1, C2, C3, C4	4	22 µF	Capacitor, Ceramic, 25 V, X5R, 10%	1206	GRM31CR61E226KE15L	Murata
C5	1	0.1 µF	CAP CER 0.1 µF 25 V 10% X5R 0402	0402	GRM155R61E104KA87D	Murata
C6, C10, C11, C12, C13, C14, C19, C21, C22, C23	10	22 µF	Capacitor, Ceramic, 6.3 V, X5R, 20%	1206	GRM31CR60J226KE19L	Murata
C7	1	0.1 µF	CAP CER 0.1 µF 50 V 10% X7R 0603	0603	GRM188R71H104KA93D	Murata
C8	1	470 pF	CAP CER 470 pF 50 V 10% X7R 0603	0603	GRM188R71H471KA01D	Murata
C9, C17	0	Open	Capacitor, Ceramic, 50 V, X7R, 10%	0603	Standard	Standard
C15, C16, C24, C27	0	Open	Capacitor, POSCAP, SMT, 2.5 V, 330 $\mu\text{F},$ 8 m $\Omega$	7343(D)	2R5TPE330M9 or 6TPE330MIL	Sanyo
C18, C20, C25, C26	4	1 μF	CAP CER 1 µF 16 V 10% X7R 0603	0603	GRM188R71C105KA12J	Murata
FID1, FID2, FID3, FID4, FID5, FID6	0		Fiducial mark. There is nothing to buy or mount.	Fiducial	N/A	N/A
J1, J3	2	ED120/2DS	Terminal Block, 2-pin, 15-A, 5,1 mm	0.4 × 0.35 inch	ED120/2DS	OST
J2	1	PEC02SAAN	Header, Male 2-pin, 100-mil spacing,	0.1 × 2 inch	PEC02SAAN	Sullins
J4, J5, J6	3	PEC05DAAN	Header, Male 2×5-pin, 100-mil spacing	0.1 × 2 × 5 inch	PEC05DAAN	Sullins
J7	1	ED555/2DS	Terminal Block, 2-pin, 6-A, 3,5 mm	0.27 × 0.25 inch	ED555/2DS	OST
L1	1	1 µH	Inductor, Power Chokes SMD	6,6 × 7,1 mm	PIMB065T-1R0MS	Cyntec
L1A	0	DNP	Inductor, High Fq Power, ±15%	0.283 × 0.433 inch	69P987xN	Vitec
LBL1	1		Thermal Transfer Printable Labels, 0.650 (W) × 0.2 inch (H) — 10,000 per roll	PCB Label 0.65 (H) × 0.2 inch (W)	THT-14-423-10	Brady
R1, R2, R14, R15	4	100 k	RES, 100 kΩ, 1%, 0.1 W, 0603	0603	CRCW0603100KFKEA	Vishay-Dale
R3	1	1 k	RES, 1 kΩ, 1%, 0.1 W, 0603	0603	CRCW06031K00FKEA	Vishay-Dale
R4	1	300 k	RES, 300 kΩ, 1%, 0.1 W, 0603	0603	RC0603FR-07300KL	Yageo America
R5, R8, R19	3	0	RES, 0 Ω, 5%, 0.1 W, 0603	0603	CRCW06030000Z0EA	Vishay-Dale
R6	1	200 k	RES, 200 kΩ, 1%, 0.1 W, 0603	0603	CRCW0603200KFKEA	Vishay-Dale
R7	0	Open	Resistor, Chip, 1/16 W, 1%	0603	Standard	Standard
R9	1	3.01	RES, 3.01 Ω, 1%, 0.125 W, 0805	0805	CRCW08053R01FKEA	Vishay-Dale
R10	1	57.6 k	RES, 57.6 kΩ, 1%, 0.1 W, 0603	0603	RC0603FR-0757K6L	Yageo America
R11	1	20 k	RES, 20.0 kΩ, 1%, 0.1 W, 0603	0603	CRCW060320K0FKEA	Vishay-Dale
R12, R13	2	150 k	RES, 150 kΩ, 1%, 0.1 W, 0603	0603	CRCW0603150KFKEA	Vishay-Dale
R16	1	1	RES, 1 Ω, 1%, 0.1 W, 0603	0603	CRCW06031R00FKEA	Vishay-Dale
R20, R21	2	10k	RES, 10 kΩ, 1%, 0.1 W, 0603	0603	CRCW060310K0FKEA	Vishay-Dale
R22	1	10	RES, 10 Ω, 1%, 0.1 W, 0603	0603	CRCW060310R0FKEA	Vishay-Dale
TP1, TP2, TP3, TP5, TP6, TP7, TP8, TP10, TP11, TP12, TP13, TP14, TP15	13	5000	Test Point, Red, Thru Hole Color Keyed	0.1 × 0.1 inch	5000	Keystone
TP4, TP9	2	5001	Test Point, Black, Thru Hole Color Keyed	0.1 × 0.1 inch	5001	Keystone
U1	1	TPS53915RVE	IC, High Performance, 12-A Single Sync. Step-Down Converter with PMBus.		TPS53915RVE	ТІ



# **10 Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision B (February 2014) to Revision C (November 2021)	Page
• Updated the numbering format for tables, figures, and cross-references throughout the document	2
Edited user's guide for clarity	<mark>2</mark>
Changed user's guide title	2
Changes from Revision A (December 2013) to Revision B (February 2014)	Page
Changed the test points in the Tin and Barrel Measurement for VOLIT Pinnle image from TPS5 and	TDS7 to

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